

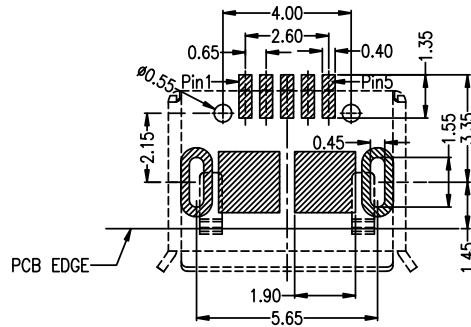
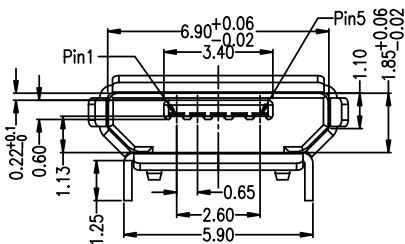
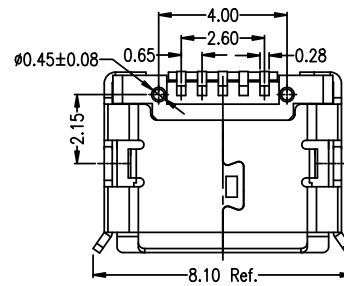
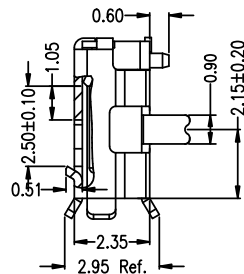
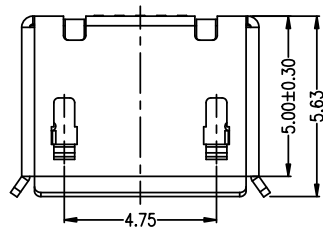
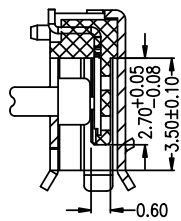
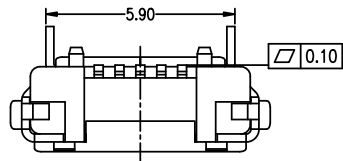
RoHS

MAPX

MODIFICATION

DRW

DATE



RECOMMENDED PCB LAYOUT

PCB图仅供参考

Note:

1.Material:

- 1.1 Housing: High temperature thermoplastic with g.f,UL94v-0
- 1.2 Contact: copper alloy,t=0.20mm
- 1.3 Shell: copper alloy,t=0.25mm

2.Specification:

- 2.1 Current rating:1,5PIN 1.8A Max/2,3,4PIN 1A Max.
- 2.2 Dielectric withstanding voltage: 100 V(ac) for 1 min.
- 2.3 Contact resistance: 30 mΩ Max.
- 2.4 Insulation resistance: 100 MΩ Min.
- 2.5 Total mating force: 3.57 Kgf Max.
- 2.6 Total unmating force: 1.0 Kgf Min.
- 2.7 Temperature range: -30°C~80°C

5	GND
4	ID
3	D+
2	D-
1	VBUS
PIN	NAME
PIN ASSIGNMENT	

产品图 PRODUCT CHART DWG		深圳市精拓金电子有限公司 Shenzhen Jing Tuo Jin Electronics Co., Ltd.					
公差一览表 TOLERANCE UNLESS OTHERWISE		单位 UNITS	MM	制图 DRAWING	林属升	制图料号 PRODUCT PART NO.	920-C52A2021S10115
.X	±0.35	.X	±5.°	比例 SCALE	1:1	审核 CHKD	郭志富
.XX	±0.30	.X	±2.°	日期 DATE	2016-09-09	核准 APPD	黄国荣
.XX	±0.20	.XX	±1.°	角法 VIEW	第三角法	版本 VER	AO
.XXX	±0.10	.XXX	±0.5°	MICRO-58 间距5.97mm长1.25有边有柱SMT短端			